Product data sheet

1. General description

WMS20N270SE is a high performance super logic level N-channel MOSFET in PDFN3.3X3.3 package, which utilizes advanced Trench MOSFET technology to provide low R_{DS(on)} and gate charge. It is designed and qualified in a wide range of industrial and consumer applications.



2. Features and benefits

- Advance High Cell Density Trench Technology
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Switching Losses
- Optimized Gate Charge to Minimize Driver Losses
- 100% UIS Tested
- RoHS Compliant, Halogen Free and Lead Free

3. Applications

- DC-DC Converters
- BLDC Motor Control
- Load Switch
- Lithium-ion Battery Protection

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit
	maximum rating	Conditions	110100		Tuiuoo		- Oille
V _{DS}	drain-source voltage				20		V
V_{GS}	gate-source voltage				±10		V
I _D	continuous drain current	V _{GS} = 4.5 V; T _{mb} = 25 °C	[1]		18		А
P _{tot}	power dissipation	T _{mb} = 25 °C		14			W
T _j	junction temperature			-55 to 150		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$R_{DS(on)}$	drain-source on-state	$V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$		-	17	27	mΩ
	resistance	$V_{GS} = 2.5 \text{ V}, I_D = 3 \text{ A}$		-	25	44	mΩ
Dynamic o	characteristics		•				
Q _{G(tot)}	total gate charge	$I_D = 8 \text{ A}; V_{DS} = 10 \text{ V}; V_{GS} = 4.5 \text{ V}$		-	5.1	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1-3	S	source	8 7 6 5	D
4	G	gate		
5-8	D	drain	0 1 2 3 4	Sym300 S

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	_	Small packing quantity		Package issue date
WMS20N270SE	PDFN3.3X3.3	WMS20N270SEJ	Reel	5000	PDFN3.3X3.3N	22-Sep-2022

7. Marking

Table 4. Marking codes

Type number	Marking codes
WMS20N270SE	2N270S

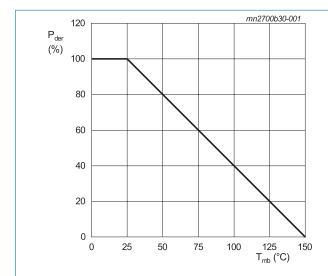
8. Limiting values

Table 5. Limiting values

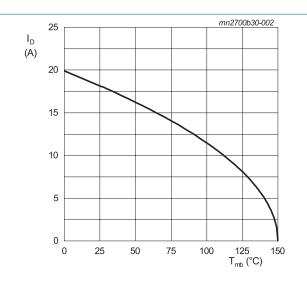
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{DS}	drain-source voltage			20	V
V _{GS}	gate-source voltage			±10	V
I _D	continuous drain current	V _{GS} = 4.5 V; T _{mb} = 25 °C	[1]	18	Α
		V _{GS} = 4.5 V; T _{mb} = 120 °C		8.9	Α
I _{DM}	pulsed drain current	t _p = 10 μs; T _{mb} = 25 °C		72	Α
P _{tot}	power dissipation	T _{mb} = 25 °C		14	W
E _{as}	single pulse drain-to- source avalanche	$I_{AS} = 7 \text{ A}; L = 0.1 \text{ mH}; R_{GS} = 25 \Omega; V_{GS} = 4.5 \text{ V}; T_j = 25 ^{\circ}\text{C}$		2.5	mJ
T _{stg}	storage temperature			-55 to 150	°C
T _j	junction temperature			-55 to 150	°C

[1] Calculated continuous current based on maximum allowable junction temperature. Package current limitation is 8A.



P_{der} = (P_{tot} / P_{tot(25 °C)}) x 100% Fig. 1. Normalized total power dissipation as a function of ambient temperature



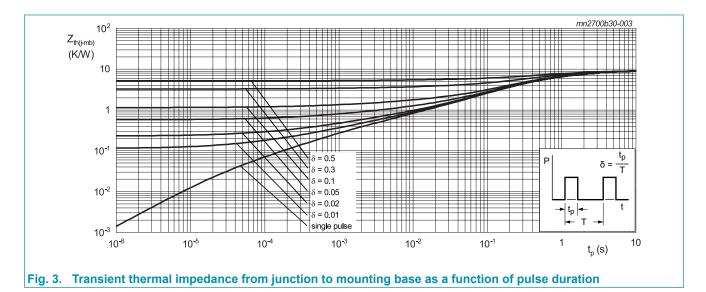
V_{GS} = 4.5 V
Fig. 2. Continuous Drain Current as a function of ambient temperature

9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base			-	7	9.1	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[2]	-	-	60	K/W

[2] Surface mount on FR4 board of 1 inch2, 1 oz copper.



10. Characteristics

Table 7. Characteristics

T_i = 25 °C unless otherwise noted

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V$		20	-	-	V
$V_{\text{GS(th)}}$	gate-source threshold voltage	$I_D = 250 \ \mu A; \ V_{DS} = V_{GS}$		0.5	0.7	1.1	V
I _{DSS}	drain leakage current	V _{DS} = 20 V; V _{GS} = 0 V		-	-	1	μA
		$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	10	μA
I _{GSS}	gate leakage current	$V_{GS} = \pm 10 \text{ V}; V_{DS} = 0 \text{ V}$		-	-	±100	nA
R _{DS(on)}	drain-source on-state	V _{GS} = 4.5 V; I _D = 8 A		-	17	27	mΩ
	resistance	V _{GS} = 2.5 V; I _D = 3 A		-	25	44	mΩ
R _G	gate resistance	f = 1 MHz		-	3.3	-	Ω
Dynamic	characteristics		'				
$Q_{G(tot)}$	total gate charge	$I_D = 8 \text{ A}; V_{DS} = 10 \text{ V}; V_{GS} = 4.5 \text{ V}$		-	5.1	-	nC
Q _{GS}	gate-source charge			-	0.7	-	nC
Q_{GD}	gate-drain charge			-	1.6	-	nC
C _{iss}	input capacitance	V _{DS} = 10 V; V _{GS} = 0 V; f = 1 MHz		-	388	-	pF
C _{oss}	output capacitance			-	79	-	pF
C _{rss}	reverse transfer capacitance			-	70	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 10 \text{ V}; V_{GS} = 10 \text{ V}; R_G = 6 \Omega;$		-	7.0	-	ns
t _r	rise time	$I_D = 8 A$		-	15	-	ns
$t_{d(off)}$	turn-off delay time			-	26	-	ns
t _f	fall time			-	12	-	ns
Source-d	rain diode						
V_{SD}	source-drain voltage	V _{GS} = 0 V; I _S = 1 A		-	0.71	1	V
		V _{GS} = 0 V; I _S = 1 A; T _j = 125 °C		-	0.55	-	V
Is	body-diode continuous current	T _{mb} = 25 °C		-	-	15	А
t _{rr}	reverse recovery time	$V_{GS} = 0 \text{ V; } I_S = 8 \text{ A; } di/dt = 100 \text{ A/}\mu\text{s}$		-	13	-	ns
Q _{rr}	reverse recovered charge			-	4.7	-	nC
I _{rrm}	reverse recovery current			-	0.6	-	Α

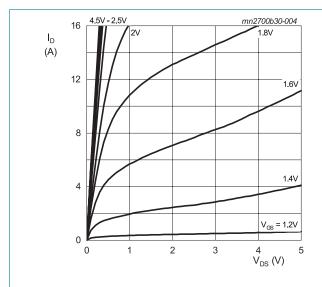
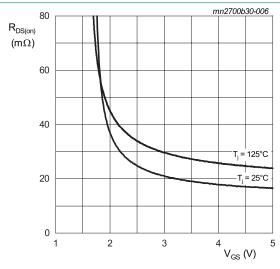
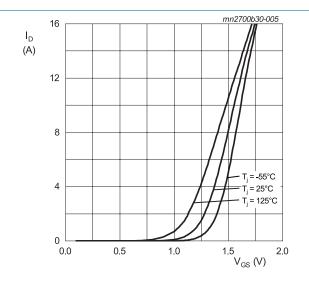


Fig. 4. Drain current as a function of drain-source voltage; typical values



V_{GS} = 4.5 V; I_D = 8 A

Fig. 6. Drain-source on-state resistance as a function of gate-source voltage; typical values



V_{DS} = 5 V
Fig. 5. Drain current as a function of gate-source voltage; typical values

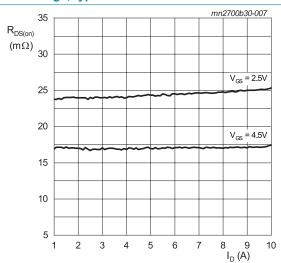
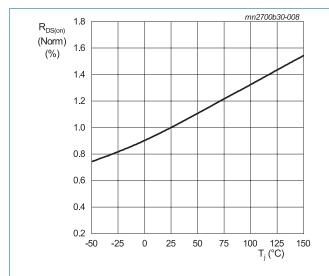
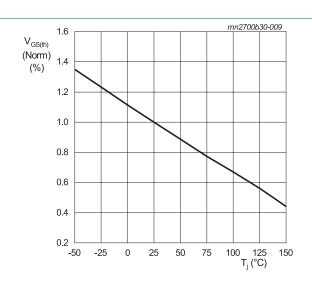


Fig. 7. Drain-source on-state resistance as a function of drain current; typical values



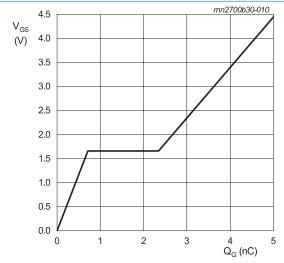
 V_{GS} = 4.5 V; I_{D} = 8 A

Fig. 8. Normalized drain-source on-state resistance as a function of junction temperature

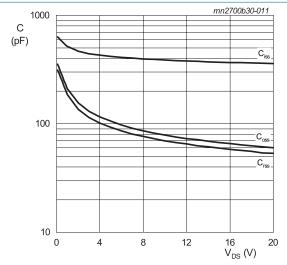


 V_{DS} = V_{GS} ; I_{D} = 250 μA

Fig. 9. Normalized gate-source threshold voltage as a function of junction temperature



 I_D = 8 A; V_{DS} = 10 V Fig. 10. Gate-source voltage as a function of gate charge; typical values

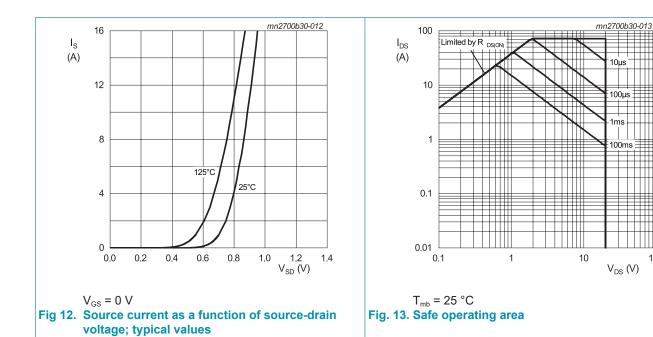


 $V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$

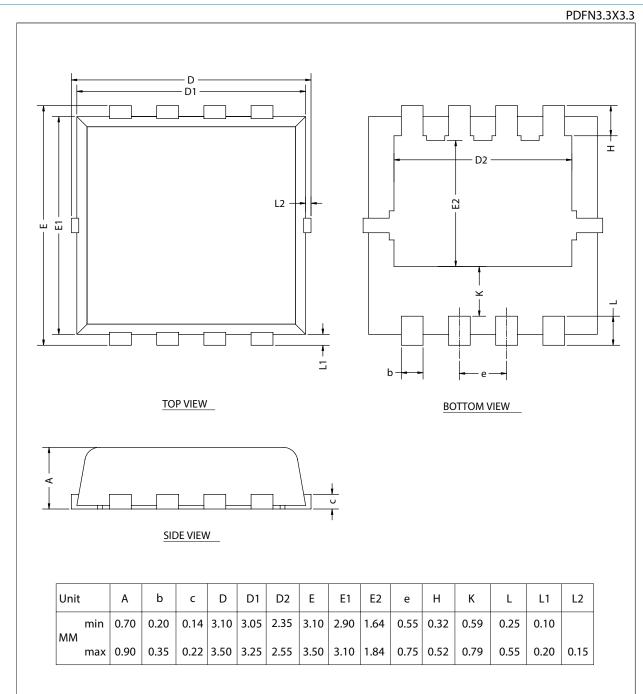
Fig 11. Capacitances as a function of drain-source voltage; typical values

100

N-Channel Silicon MOSFET



11. Package outline



Note

1. All dimensions don't include mold flash and metal protrusion.

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Date of release: 18 January 2023

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